Lead-free Green

## Features

## Mechanical Data

- $\mathrm{BV}_{\text {CEO }}>-100 \mathrm{~V}$
- $B V_{\mathrm{ECO}}>-7 \mathrm{~V}$
- $\mathrm{I}_{\mathrm{C}}=-2 \mathrm{~A}$ Continuous Collector Current
- $\mathrm{V}_{\mathrm{CE}(\text { (SAT })}<-130 \mathrm{mV}$ @ -1A

Case: SOT23

- Case Material: Molded Plastic, "Green" Molding Compound. UL

Flammability Classification Rating 94V-0

- Moisture Sensitivity: Level 1 per J-STD-020
- $\quad$ RCE(SAT) $=108 \mathrm{~m} \Omega$ Typical
- $\mathrm{PD}_{\mathrm{D}}=1.25 \mathrm{~W}$
- High Peak Current
- Complementary Part Number ZXTN25100BFH
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 © ${ }^{\text {e3 }}$
- Weight: 0.008 grams (Approximate)


## Applications

- MOSFET and IGBT Gate Driving
- DC-DC Converters
- Motor Drive
- Relay, Lamp and Solenoid Drive



## Ordering Information (Note 4)

| Part Number | Marking | Reel Size (inches) | Tape Width (mm) | Quantity Per Reel |
| :---: | :---: | :---: | :---: | :---: |
| ZXTP25100BFHTA | 056 | 7 | 8 | 3,000 |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) \& 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



Absolute Maximum Ratings $\left(@ T_{A}=+25^{\circ} \mathrm{C}\right.$, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Collector-Base Voltage | $\mathrm{V}_{\text {CBO }}$ | -140 | V |
| Collector-Emitter Voltage (Forward Blocking) | $\mathrm{V}_{\text {CEO }}$ | -100 | V |
| Emitter-Collector Voltage (Reverse Blocking) | $\mathrm{V}_{\text {ECO }}$ | -7 | V |
| Emitter-Base Voltage | $\mathrm{V}_{\text {EBO }}$ | -7 | V |
| Continuous Collector Current (Note 5) | $\mathrm{I}_{\mathrm{C}}$ | -2 | A |
| Peak Pulse Current | $\mathrm{I}_{\text {CM }}$ | -5 | A |

Thermal Characteristics (@ $\mathrm{T}_{\mathrm{A}}=+22^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Power Dissipation <br> Linear Derating Factor | (Note 5) | PD | $\begin{aligned} & 0.73 \\ & 5.84 \end{aligned}$ | W |
|  | (Note 6) |  | $\begin{gathered} 1.05 \\ 8.4 \end{gathered}$ |  |
|  | (Note 7) |  | $\begin{gathered} 1.25 \\ 9.6 \end{gathered}$ |  |
|  | (Note 8) |  | $\begin{aligned} & 1.81 \\ & 14.5 \end{aligned}$ |  |
| Thermal Resistance, Junction to Ambient | (Note 5) | $\mathrm{R}_{\text {өJA }}$ | 171 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | (Note 6) |  | 119 |  |
|  | (Note 7) |  | 100 |  |
|  | (Note 8) |  | 69 |  |
| Thermal Resistance, Junction to Lead | (Note 9) | $\mathrm{R}_{\text {өJL }}$ | 74.95 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | - | $\mathrm{T}_{\text {J, }}$ TSTG | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Notes: $\quad 5$. For a device surface mounted on $15 \mathrm{~mm} \times 15 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ FR-4 PCB with high coverage of single sided $10 z$ copper, in still air conditions; the device is measured when operating in a steady-state condition.
6. Same as note (5), except the device is surface mounted on $25 \mathrm{~mm} \times 25 \mathrm{~mm}$ with 2 oz copper.
7. Same as note (5), except the device is surface mounted on $50 \mathrm{~mm} \times 50 \mathrm{~mm}$ with 2 oz copper.
8. Same as note (6), except the device is measured at $\mathrm{t}<5 \mathrm{secs}$.
9. Thermal resistance from junction to solder-point (at the end of the collector lead).

ESD Ratings (Note 10)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
| :--- | :---: | :---: | :---: | :---: |
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3 A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | C |

Note: 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

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## Thermal Characteristics and Derating Information



Electrical Characteristics ( $@ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-Base Breakdown Voltage | BV ${ }_{\text {CBO }}$ | -140 | -165 | - | V | $\mathrm{IC}=-100 \mu \mathrm{~A}$ |
| Collector-Emitter Breakdown Voltage (Note 11) | BV ${ }_{\text {CEO }}$ | -100 | -125 | - | V | $\mathrm{IC}=-10 \mathrm{~mA}$ |
| Collector-Emitter Breakdown Voltage | BVCEX | -140 | -165 | - | V | $\begin{aligned} & \mathrm{I}_{\mathrm{E}}=-100 \mu \mathrm{~A}, \mathrm{R}_{\mathrm{BC}}<1 \mathrm{k} \Omega \text { or } \\ & -0.25<\mathrm{V}_{\mathrm{BE}}<1 \mathrm{~V} \end{aligned}$ |
| Emitter-Base Breakdown Voltage | $\mathrm{BV}_{\text {EBO }}$ | -7 | -8.2 | - | V | $\mathrm{I}_{\mathrm{E}}=-100 \mu \mathrm{~A}$ |
| Collector-Base Cutoff Current | Icbo | - | <-1 | -50 | nA | $\mathrm{V}_{\mathrm{CB}}=-112 \mathrm{~V}$ |
|  |  | - | - | -20 | $\mu \mathrm{A}$ | $\mathrm{V}_{C B}=-112 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+100^{\circ} \mathrm{C}$ |
| Emitter-Base Cutoff Current | $\mathrm{I}_{\text {EBO }}$ | - | <-1 | -50 | nA | $\mathrm{V}_{\text {EB }}=-5.6 \mathrm{~V}$ |
| Static Forward Current Transfer Ratio (Note 11) | $h_{\text {FE }}$ | 100 | 200 | 300 | - | $\mathrm{I}_{\mathrm{C}}=-10 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=-2 \mathrm{~V}$ |
|  |  | 55 | 105 | - |  | $\mathrm{I}_{\mathrm{C}}=-1 \mathrm{~A}, \mathrm{~V}_{\text {CE }}=-2 \mathrm{~V}$ |
|  |  | 15 | 25 | - |  | $\mathrm{I}_{\mathrm{C}}=-2 \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=-2 \mathrm{~V}$ |
| Collector-Emitter Saturation Voltage (Note 11) | $\mathrm{V}_{\text {CE(SAT }}$ | - | -60 | -90 | mV | $\mathrm{I}_{\mathrm{C}}=-0.5 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-50 \mathrm{~mA}$ |
|  |  | - | -240 | -350 |  | $\mathrm{I}_{\mathrm{C}}=-0.5 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-10 \mathrm{~mA}$ |
|  |  | - | -100 | -130 |  | $\mathrm{I}_{\mathrm{C}}=-1 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-100 \mathrm{~mA}$ |
|  |  | - | -215 | -295 |  | $\mathrm{I}_{\mathrm{C}}=-2 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-200 \mathrm{~mA}$ |
| Base-Emitter Saturation Voltage (Note 11) | $\mathrm{V}_{\text {BE(SAT }}$ | - | -900 | -1000 | mV | $\mathrm{I}_{\mathrm{C}}=-2 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-200 \mathrm{~mA}$ |
| Base-Emitter Voltage (Note 11) | $\mathrm{V}_{\mathrm{BE}}(\mathrm{ON})$ | - | -830 | -950 | mV | $\mathrm{I}_{\mathrm{C}}=-2 \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=-2 \mathrm{~V}$ |
| Output Capacitance | Сово | - | 15 | 25 | pF | $\mathrm{V}_{C B}=-10 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |
| Transition Frequency | $\mathrm{f}_{\mathrm{T}}$ | - | 200 | - | MHz | $\begin{aligned} & V_{C E}=-5 \mathrm{~V}, \mathrm{IC}=-100 \mathrm{~mA}, \\ & \mathrm{f}=100 \mathrm{MHz} \end{aligned}$ |
| Turn-on Time | $\mathrm{t}_{(\mathrm{ON})}$ | - | 31 | - | ns | $\mathrm{V}_{\mathrm{CC}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-500 \mathrm{~mA}$, |
| Turn-off Time | t(OFF) | - | 384 | - | ns | $\mathrm{I}_{\mathrm{B} 1}=-\mathrm{I}_{\mathrm{B} 2}=-50 \mathrm{~mA}$ |

Note: $\quad$ 11. Measured under pulsed conditions. Pulse width $\leq 300 \mu$ s. Duty cycle $\leq 2 \%$.

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Typical Electrical Characteristics $\left(@ T_{A}=+25^{\circ} \mathrm{C}\right.$, unless otherwise specified.)


## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

## SOT23



| SOT23 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.890 | 1.00 | 0.975 |
| K1 | 0.903 | 1.10 | 1.025 |
| L | 0.45 | 0.61 | 0.55 |
| L1 | 0.25 | 0.55 | 0.40 |
| M | 0.085 | 0.150 | 0.110 |
| a | $0^{\circ}$ | $8^{\circ}$ | -- |
| All Dimensions in $\mathbf{~ m m}$ |  |  |  |
|  |  |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

## SOT23



| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{C}$ | 2.0 |
| $\mathbf{X}$ | 0.8 |
| $\mathbf{X 1}$ | 1.35 |
| $\mathbf{Y}$ | 0.9 |
| $\mathbf{Y 1}$ | 2.9 |

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